PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q60938

Takashi ABE

Appln. No.: 09/685,771

RECEIVED

Group Art Unit: 2827

Confirmation No.: 5049

JAN 3 1 2003

Examiner: I. Patel

Filed: October 11, 2000

OFFICE OF PETITIONS

For:

CIRCUIT BOARD

STATEMENT UNDER 37 C.F.R. § 1.704(d)

Commissioner for Patents Washington, D.C. 20231

Sir:

The undersigned hereby states, upon information and belief:

That each item of information contained in the Information Disclosure Statement filed concurrently herewith was cited in a communication from a foreign patent office in a counterpart foreign application, and that the communication was not received by any individual designated in 37 C.F.R. § 1.56(c) more than thirty days prior to the filing of said Information Disclosure Statement.

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Respectfully submitted,

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WASHINGTON OFFICE

73373

PATENT TRADEMARK OFFICE

Date: January 31, 2002

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INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §§ 1.97 and 1.98

Commissioner for Patents Washington, D.C. 20231

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08 A & B (modified) form and listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

- 1. Japanese Unexamined Patent Publication No. 7-263871, published October 13, 1995.
- 2. Japanese Unexamined Patent Publication No. 11-220263, published August 10, 1999.
- 3. Japanese Unexamined Patent Publication No. 4-261098, published September 17, 1992.

One copy of each of the listed documents is submitted herewith.

The present Information Disclosure Statement is being filed: (1) No later than three months from the application's filing date for an application other than a continued prosecution application (CPA) under §1.53(d); (2) Before the mailing date of the first Office Action on the



U.S. Appln. No.: 09/685,771

merits (whichever is later); or (3) Before the mailing date of the first Office Action after filing a request for continued examination (RCE) under §1.114, and therefore, no Statement under 37 C.F.R. § 1.97(e) or fee under 37 C.F.R. § 1.17(p) is required.

The present Information Disclosure Statement is being filed thirty days or fewer from the communication from a foreign patent office and a Statement Under 37 C.F.R. §1.704(d) is attached.

In compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) for foreign language documents, Applicant encloses here with a copy of a corresponding Japanese Office Action dated January 21, 2003 and an English translation of the pertinent portions thereof which cites such documents and indicates the degree of relevance found by the foreign office.

The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant does not waive any right to take any action that would be appropriate to antedate or otherwise remove any listed document as a competent reference against the claims of the present application.

Respectfully submitted,

Howard L. Bernstein

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WASHINGTON OFFICE

Date: January 31, 2003





Complete if Known

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09/685,771

October 11, 2000

Substitute for Form 1449 A & B/PTO

Sheet

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

	First Named Inventor	Takashi ABE	
(use as many sheets as necessary)	Art Unit	2827	_
(use as many sneeds as needstary)	Examiner Name	I. Patel	
1 of 1	Attorney Docket Number	Q60938	

Filing Date

Application Number

Confirmation Number

			U.S. P	ATENT DOCUME	ENTS
Examiner Initials*	Cite No.1	Document	Document Number		
		Number	Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		US			
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		US			OFFICE OF PETITIONS

			F	OREIGN PA	TENT DOCUME	ENTS	
Examiner Cite Initials* No.1	Cite	Foreign Patent Document			Publication Date	Name of Patentee or	Translation ⁶
		Country Code ³	Number ⁴	Kind Code ⁵ (if known)		Applicant of Cited Document	
		JP	7-263871		10-13-1995		No
		JР	11-220263		08-10-1999		No
		JP	4-261098		09-17-1992		No
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OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation ⁶	

Examiner Signature	Date Considered	
Examiner Signature		

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to indicate here if English language Translation is attached.

Ref. Q60938

• Claims: 1 through 6

Cited Literature: 1 through 3

Remarks:

Cited Literature 1 through 3 describe a circuit substrate equipped with a ground plane on the obverse and the reverse where electronic components are implemented.

In addition, Cited Literature 1 describes a shorting plane on the edge of the substrate that short-circuits the ground layer.

List of Cited Literature

- 1. Japanese Unexamined Patent Application Publication H7-263871
- 2. Japanese Unexamined Patent Application Publication H11-220263
- 3. Japanese Unexamined Patent Application Publication H4-261098